



SPECIFICATIONS:

- INSULATION RESISTANCE BETWEEN ANY ADJACENT OPEN CIRCUIT TERMINAL SHELL NOT BE LESS THAN 100MΩ MEASURED BY 500 VDC.
- CONTACT RESISTANCE: 50mΩ MAX(INITIAL).
- INSULATION VOLTAGE WITHSTAND:500V AC FOR ONE MINUTE.
- UNLESS OTHERWISE SPECIFIED, TEST IS TO BE MADE AT 5-35°C IN TEMPERATURE AND 45-85% IN HUMIDITY. BUT,IF ANY VAGUE DATA IS OCCURED ON TEST RESULT, ANOTHER TEST SHALL BE MADE AT 20°C±2°C IN TEMP., 60-70% IN HUMIDITY.
- LIFE TEST: 5,000 CYCLES MIN.
- INSERTION FORCE: 0.3 - 3kg.
- WITHDRAWAL FORCE: 0.3 - 3kg.
- AFTER LIFE TEST, CONTACT RESISTANCE: 100mΩ MAX.
- AFTER HUMIDITY TEST, INSULATION RESISTANCE: 50MΩ MIN.
- PACKING : TAPE & REEL.
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT.
- HALOGEN FREE PRODUCT IDENTIFICATION LOGO ON PACKAGING.

K	MYLAR	1	L*W*T(10*9*6*0.1)	BROWN
J	SHELL	1	SUS304-1/2H 0.2t	Ni 60u Min.
H	SEPARATOR	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
G	TRANSFER TERMINAL	1	PHOSPHOR BRONZE 0.2t	GOLD FLASH ON CONTACT AREA GOLD FLASH ON SOLDER AREA ALL OVER 50u" Ni
F	MAKE TERMINAL	1	PHOSPHOR BRONZE 0.2t	GOLD FLASH ON CONTACT AREA Make Solder" ON SOLDER AREA ALL OVER 50u" Ni
E	TIP SPRING	1	SUS304-1/2H 0.2t	GOLD FLASH ON CONTACT AREA GOLD FLASH ON SOLDER AREA ALL OVER 50u" Ni
D	RING A	1	PHOSPHOR BRONZE 0.2t	GOLD FLASH ON CONTACT AREA
C	RING B	1	PHOSPHOR BRONZE 0.2t	Make Solder" ON SOLDER AREA ALL OVER 50u" Ni
B	EARTH	1	PHOSPHOR BRONZE 0.2t	ALL OVER 50u" Ni
A	BODY	1	PA4T+30%GF(TX1) UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES				
DECIMALS: ANGLES:				
X	:±0.5	X	:±2°	
X.X	:±0.3	X.X	:±1°	
X.XX	:±0.2			
TITLE: 3.5Ø PHONE JACK				
DWG: Julio				
CHKD: Bruce				
APVD: Lussen				
PART NO.2S3108-071111F				
SCALE: 4:1				
UNIT: mm				
SIZE: A3				
SHEET: 1 OF 1				
REV: A				
CUSTOMER COPY				

Singatron Enterprise Co., Ltd.  
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